



<b>Form 1449 (Modified)</b>  <b>Information Disclosure Statement By Applicant</b>  (Use Several Sheets if Necessary)	<table style="width: 100%;"> <tr> <td style="width: 50%;"> <b>Atty Docket No.</b>            APL1P193/P2369  <b>Applicant:</b>            Lam et al.  <b>Filing Date</b>            September 3, 1999         </td> <td style="width: 50%;"> <b>Application No.:</b>            09/389,915   <b>Group</b>            2835         </td> </tr> </table>	<b>Atty Docket No.</b> APL1P193/P2369 <b>Applicant:</b> Lam et al. <b>Filing Date</b> September 3, 1999	<b>Application No.:</b> 09/389,915  <b>Group</b> 2835
<b>Atty Docket No.</b> APL1P193/P2369 <b>Applicant:</b> Lam et al. <b>Filing Date</b> September 3, 1999	<b>Application No.:</b> 09/389,915  <b>Group</b> 2835		

**U.S. Patent Documents**

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
<i>Y/L</i>                     	A	4,847,736	07-11-89	Ho			08-17-88
	B	6,035,180	03-07-00	Kubes et al.			10-07-97
	C	6,476,726	11-05-02	Pederson			07-28-00
	D	6,690,362	02-10-04	Motoyama et al.			09-15-00
	E	6,720,745	04-13-04	Lys et al.			12-17-98
	F	6,816,149	11-09-04	Alsleben			04-23-02
	G	6,888,322	05-03-05	Dowling et al.			07-27-01
	H	2003/0161093	08-28-03	Lam et al.			09-03-99
	I	2004/0141321	07-22-04	Dowling et al.			11-18-03
	J	2004/0201573	10-14-04	Yu et al.			04-10-03
	K	2005/0036300	02-17-05	Dowling et al.			09-05-03
<i>Y/L</i>	L	2005/0047132	03-03-05	Dowling et al.			08-06-04

**Foreign Patent or Published Foreign Patent Application**

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No
	M							
	N							
	O							
	P							
	Q							

**Other Documents**

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
	R	
	S	
	T	
<b>Examiner</b> <i>[Signature]</i>	<b>Date Considered</b> <i>8/29/05</i>	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.